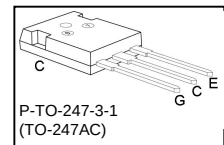
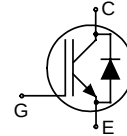


## Fast IGBT in NPT-technology with soft, fast recovery anti-parallel EmCon diode

- 40% lower  $E_{off}$  compared to previous generation
- Short circuit withstand time – 10  $\mu$ s
- Designed for:
  - Motor controls
  - Inverter
  - SMPS
- NPT-Technology offers:
  - very tight parameter distribution
  - high ruggedness, temperature stable behaviour
  - parallel switching capability



- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>

| Type      | $V_{CE}$ | $I_C$ | $E_{off}$ | $T_j$ | Package  | Ordering Code |
|-----------|----------|-------|-----------|-------|----------|---------------|
| SKW15N120 | 1200V    | 15A   | 1.5mJ     | 150°C | TO-247AC | Q67040-S4281  |

### Maximum Ratings

| Parameter                                                                                    | Symbol         | Value      | Unit             |
|----------------------------------------------------------------------------------------------|----------------|------------|------------------|
| Collector-emitter voltage                                                                    | $V_{CE}$       | 1200       | V                |
| DC collector current                                                                         | $I_C$          | 30         | A                |
| $T_C = 25^\circ\text{C}$                                                                     |                | 15         |                  |
| $T_C = 100^\circ\text{C}$                                                                    |                |            |                  |
| Pulsed collector current, $t_p$ limited by $T_{jmax}$                                        | $I_{Cpuls}$    | 52         |                  |
| Turn off safe operating area                                                                 | -              | 52         |                  |
| $V_{CE} \leq 1200\text{V}, T_j \leq 150^\circ\text{C}$                                       |                |            |                  |
| Diode forward current                                                                        | $I_F$          | 32         |                  |
| $T_C = 25^\circ\text{C}$                                                                     |                | 15         |                  |
| $T_C = 100^\circ\text{C}$                                                                    |                |            |                  |
| Diode pulsed current, $t_p$ limited by $T_{jmax}$                                            | $I_{Fpuls}$    | 50         |                  |
| Gate-emitter voltage                                                                         | $V_{GE}$       | $\pm 20$   | V                |
| Short circuit withstand time <sup>1)</sup>                                                   | $t_{SC}$       | 10         | $\mu$ s          |
| $V_{GE} = 15\text{V}, 100\text{V} \leq V_{CC} \leq 1200\text{V}, T_j \leq 150^\circ\text{C}$ |                |            |                  |
| Power dissipation                                                                            | $P_{tot}$      | 198        | W                |
| $T_C = 25^\circ\text{C}$                                                                     |                |            |                  |
| Operating junction and storage temperature                                                   | $T_j, T_{stg}$ | -55...+150 | $^\circ\text{C}$ |
| Soldering temperature, 1.6mm (0.063 in.) from case for 10s                                   | -              | 260        |                  |

<sup>1)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

## Thermal Resistance

| Parameter                                    | Symbol      | Conditions | Max. Value | Unit |
|----------------------------------------------|-------------|------------|------------|------|
| <b>Characteristic</b>                        |             |            |            |      |
| IGBT thermal resistance,<br>junction – case  | $R_{thJC}$  |            | 0.63       | K/W  |
| Diode thermal resistance,<br>junction – case | $R_{thJCD}$ |            | 1.5        |      |
| Thermal resistance,<br>junction – ambient    | $R_{thJA}$  | TO-247AC   | 40         |      |

## Electrical Characteristic, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter                                                         | Symbol        | Conditions                                                                                     | Value    |             |            | Unit    |
|-------------------------------------------------------------------|---------------|------------------------------------------------------------------------------------------------|----------|-------------|------------|---------|
|                                                                   |               |                                                                                                | min.     | typ.        | max.       |         |
| Static Characteristic                                             |               |                                                                                                |          |             |            |         |
| Collector-emitter breakdown voltage                               | $V_{(BR)CES}$ | $V_{GE}=0V$ ,<br>$I_C=1000\mu A$                                                               | 1200     | -           | -          | V       |
| Collector-emitter saturation voltage                              | $V_{CE(sat)}$ | $V_{GE} = 15V$ , $I_C=15A$<br>$T_j=25^{\circ}C$<br>$T_j=150^{\circ}C$                          | 2.5<br>- | 3.1<br>3.7  | 3.6<br>4.3 |         |
| Diode forward voltage                                             | $V_F$         | $V_{GE}=0V$ , $I_F=15A$<br>$T_j=25^{\circ}C$<br>$T_j=150^{\circ}C$                             | -        | 2.0<br>1.75 | 2.5        |         |
| Gate-emitter threshold voltage                                    | $V_{GE(th)}$  | $I_C=600\mu A$ , $V_{CE}=V_{GE}$                                                               | 3        | 4           | 5          |         |
| Zero gate voltage collector current                               | $I_{CES}$     | $V_{CE}=1200V$ , $V_{GE}=0V$<br>$T_j=25^{\circ}C$<br>$T_j=150^{\circ}C$                        | -<br>-   | -<br>-      | 200<br>800 | $\mu A$ |
| Gate-emitter leakage current                                      | $I_{GES}$     | $V_{CE}=0V$ , $V_{GE}=20V$                                                                     | -        | -           | 100        |         |
| Transconductance                                                  | $g_{fs}$      | $V_{CE}=20V$ , $I_C=15A$                                                                       |          | 11          | -          | S       |
| Dynamic Characteristic                                            |               |                                                                                                |          |             |            |         |
| Input capacitance                                                 | $C_{iss}$     | $V_{CE}=25V$ ,<br>$V_{GE}=0V$ ,<br>$f=1MHz$                                                    | -        | 1250        | 1500       | pF      |
| Output capacitance                                                | $C_{oss}$     |                                                                                                | -        | 155         | 185        |         |
| Reverse transfer capacitance                                      | $C_{rss}$     |                                                                                                | -        | 65          | 80         |         |
| Gate charge                                                       | $Q_{Gate}$    | $V_{CC}=960V$ , $I_C=15A$<br>$V_{GE}=15V$                                                      | -        | 130         | 175        | nC      |
| Internal emitter inductance<br>measured 5mm (0.197 in.) from case | $L_E$         | TO-247AC                                                                                       | -        | 13          | -          | nH      |
| Short circuit collector current <sup>1)</sup>                     | $I_{C(SC)}$   | $V_{GE}=15V$ , $t_{SC}\leq 10\mu s$<br>$100V\leq V_{CC}\leq 1200V$ ,<br>$T_j\leq 150^{\circ}C$ | -        | 145         | -          | A       |

<sup>1)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

## Switching Characteristic, Inductive Load, at $T_j=25^\circ\text{C}$

| Parameter              | Symbol       | Conditions                                                                                                                          | Value                                     |      |      | Unit |     |
|------------------------|--------------|-------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------|------|------|------|-----|
|                        |              |                                                                                                                                     | min.                                      | typ. | max. |      |     |
| IGBT Characteristic    |              |                                                                                                                                     |                                           |      |      |      |     |
| Turn-on delay time     | $t_{d(on)}$  | $T_j=25^{\circ}\text{C}$ ,<br>$V_{CC}=800\text{V}$ , $I_C=15\text{A}$ ,<br>$V_{GE}=15\text{V}/0\text{V}$ ,<br>$R_G=33\Omega$ ,      | -                                         | 18   | 24   | ns   |     |
| Rise time              | $t_r$        |                                                                                                                                     | $V_{CC}=800\text{V}$ , $I_C=15\text{A}$ , | -    | 23   |      | 30  |
| Turn-off delay time    | $t_{d(off)}$ |                                                                                                                                     | $V_{GE}=15\text{V}/0\text{V}$ ,           | -    | 580  |      | 750 |
| Fall time              | $t_f$        |                                                                                                                                     | $R_G=33\Omega$ ,                          | -    | 22   |      | 29  |
| Turn-on energy         | $E_{on}$     | $L_{\sigma}^{1)}=180\text{nH}$ ,<br>$C_{\sigma}^{1)}=40\text{pF}$<br>Energy losses include<br>“tail” and diode<br>reverse recovery. | -                                         | 1.1  | 1.5  | mJ   |     |
| Turn-off energy        | $E_{off}$    |                                                                                                                                     | -                                         | 0.8  | 1.1  |      |     |
| Total switching energy | $E_{ts}$     |                                                                                                                                     | -                                         | 1.9  | 2.6  |      |     |

## Anti-Parallel Diode Characteristic

|                                                                  |              |                                                                                                         |   |     |  |                  |
|------------------------------------------------------------------|--------------|---------------------------------------------------------------------------------------------------------|---|-----|--|------------------|
| Diode reverse recovery time                                      | $t_{rr}$     | $T_j=25^\circ\text{C}$ ,<br>$V_R=800\text{V}$ , $I_F=15\text{A}$ ,<br>$di_F/dt=650\text{A}/\mu\text{s}$ | - | 65  |  | ns               |
|                                                                  | $t_S$        |                                                                                                         | - |     |  |                  |
|                                                                  | $t_F$        |                                                                                                         | - |     |  |                  |
| Diode reverse recovery charge                                    | $Q_{rr}$     |                                                                                                         | - | 0.5 |  | $\mu\text{C}$    |
| Diode peak reverse recovery current                              | $I_{rrm}$    |                                                                                                         | - | 15  |  | A                |
| Diode peak rate of fall of reverse recovery current during $t_F$ | $di_{rr}/dt$ |                                                                                                         | - | 500 |  | A/ $\mu\text{s}$ |

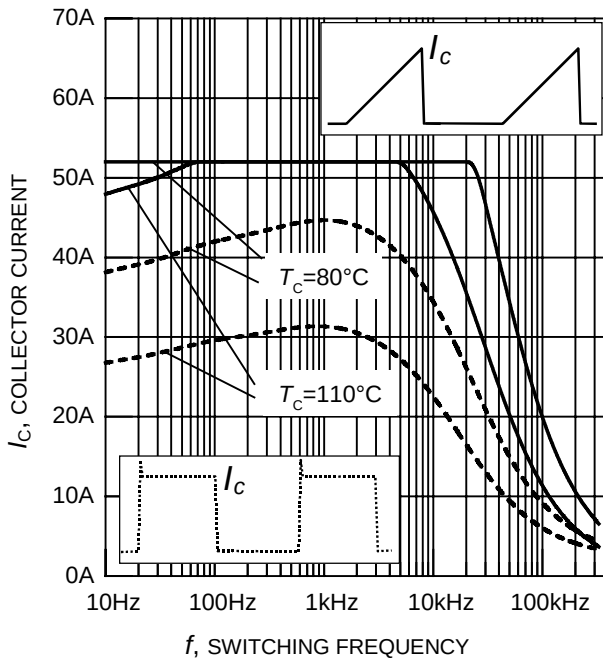
## Switching Characteristic, Inductive Load, at $T_j=150^\circ\text{C}$

| Parameter              | Symbol       | Conditions                                                                                                                                                                                                                                                              | Value |      |      | Unit |
|------------------------|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|------|------|
|                        |              |                                                                                                                                                                                                                                                                         | min.  | typ. | max. |      |
| IGBT Characteristic    |              |                                                                                                                                                                                                                                                                         |       |      |      |      |
| Turn-on delay time     | $t_{d(on)}$  | $T_j=150^{\circ}\text{C}$<br>$V_{CC}=800\text{V}$ ,<br>$I_C=15\text{A}$ ,<br>$V_{GE}=15\text{V}/0\text{V}$ ,<br>$R_G=33\Omega$ ,<br>$L_{\sigma}^{1)}=180\text{nH}$ ,<br>$C_{\sigma}^{1)}=40\text{pF}$<br>Energy losses include<br>“tail” and diode<br>reverse recovery. | -     | 38   | 46   | ns   |
| Rise time              | $t_r$        |                                                                                                                                                                                                                                                                         | -     | 30   | 36   |      |
| Turn-off delay time    | $t_{d(off)}$ |                                                                                                                                                                                                                                                                         | -     | 652  | 780  |      |
| Fall time              | $t_f$        |                                                                                                                                                                                                                                                                         | -     | 31   | 37   |      |
| Turn-on energy         | $E_{on}$     |                                                                                                                                                                                                                                                                         | -     | 1.9  | 2.3  | mJ   |
| Turn-off energy        | $E_{off}$    |                                                                                                                                                                                                                                                                         | -     | 1.5  | 2.0  |      |
| Total switching energy | $E_{ts}$     |                                                                                                                                                                                                                                                                         | -     | 3.4  | 4.3  |      |

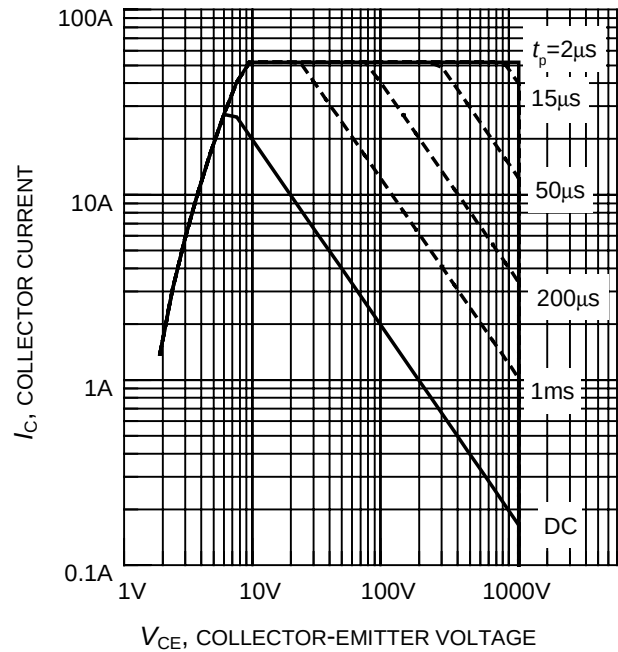
## Anti-Parallel Diode Characteristic

|                                                                  |              |                                                                                                        |   |     |  |                  |
|------------------------------------------------------------------|--------------|--------------------------------------------------------------------------------------------------------|---|-----|--|------------------|
| Diode reverse recovery time                                      | $t_{rr}$     | $T_j=150^\circ\text{C}$<br>$V_R=800\text{V}$ , $I_F=15\text{A}$ ,<br>$di_F/dt=650\text{A}/\mu\text{s}$ | - | 200 |  | ns               |
|                                                                  | $t_S$        |                                                                                                        | - |     |  |                  |
|                                                                  | $t_F$        |                                                                                                        | - |     |  |                  |
| Diode reverse recovery charge                                    | $Q_{rr}$     |                                                                                                        | - | 2.0 |  | $\mu\text{C}$    |
| Diode peak reverse recovery current                              | $I_{rrm}$    |                                                                                                        | - | 23  |  | A                |
| Diode peak rate of fall of reverse recovery current during $t_F$ | $di_{rr}/dt$ |                                                                                                        | - | 140 |  | A/ $\mu\text{s}$ |

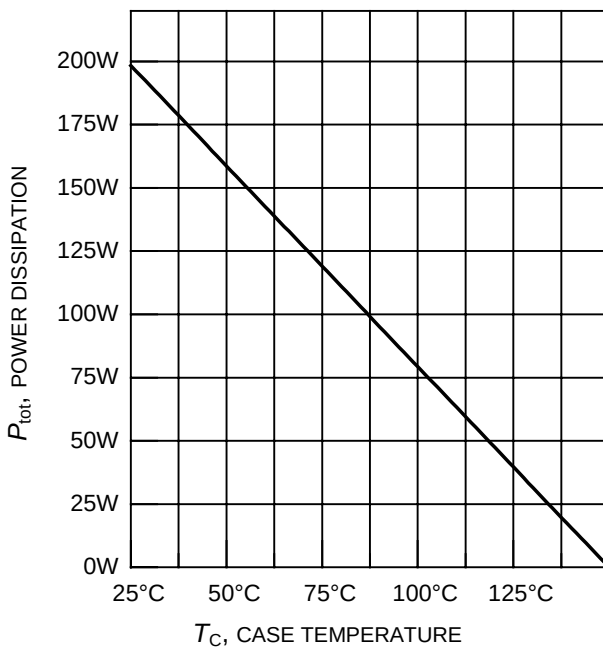
<sup>1)</sup> Leakage inductance  $L_\sigma$  and stray capacity  $C_\sigma$  due to dynamic test circuit in figure E.



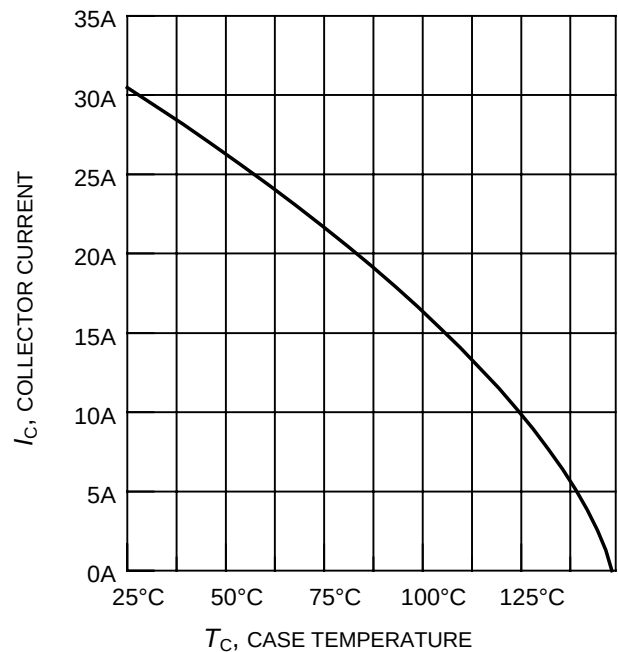
**Figure 1. Collector current as a function of switching frequency**  
 $(T_j \leq 150^\circ\text{C}, D = 0.5, V_{CE} = 800\text{V}, V_{GE} = +15\text{V}/0\text{V}, R_G = 33\Omega)$



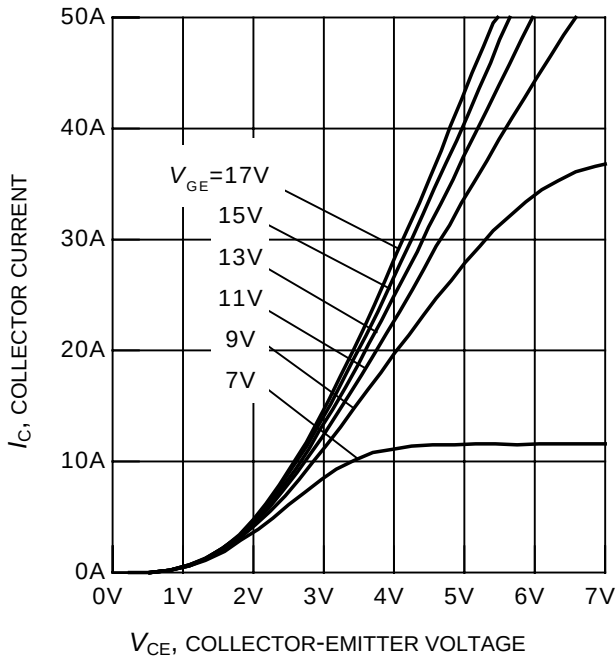
**Figure 2. Safe operating area**  
 $(D = 0, T_C = 25^\circ\text{C}, T_j \leq 150^\circ\text{C})$



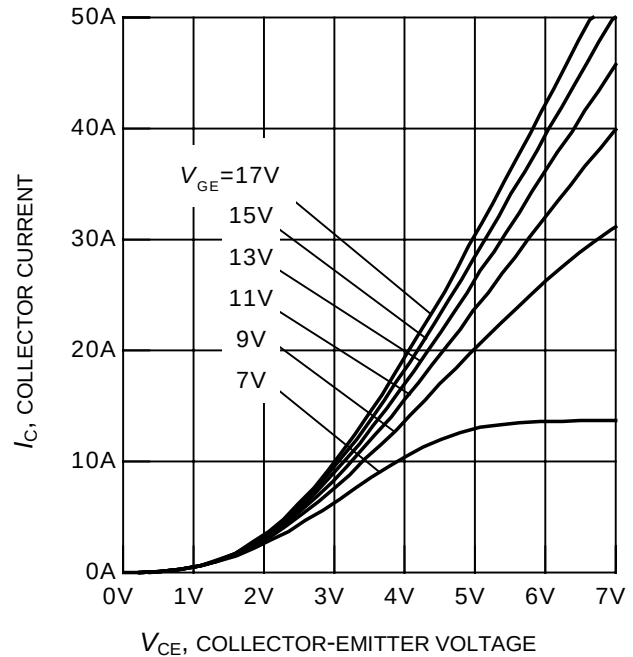
**Figure 3. Power dissipation as a function of case temperature**  
 $(T_j \leq 150^\circ\text{C})$



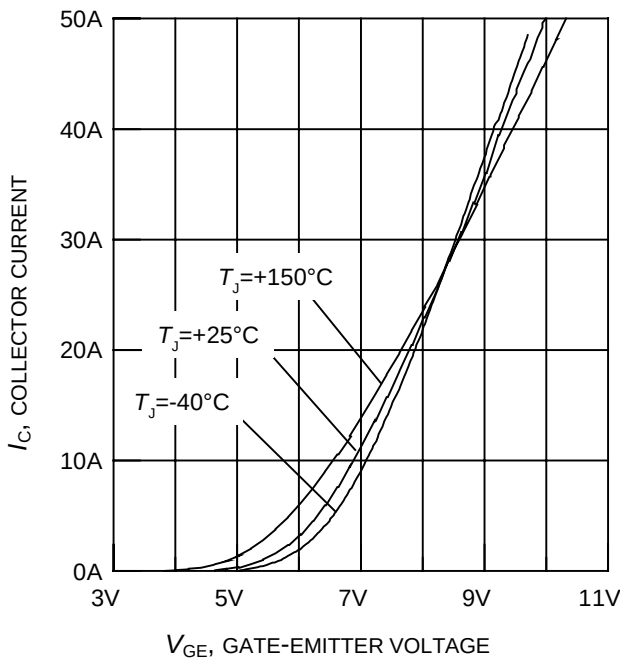
**Figure 4. Collector current as a function of case temperature**  
 $(V_{GE} \leq 15\text{V}, T_j \leq 150^\circ\text{C})$



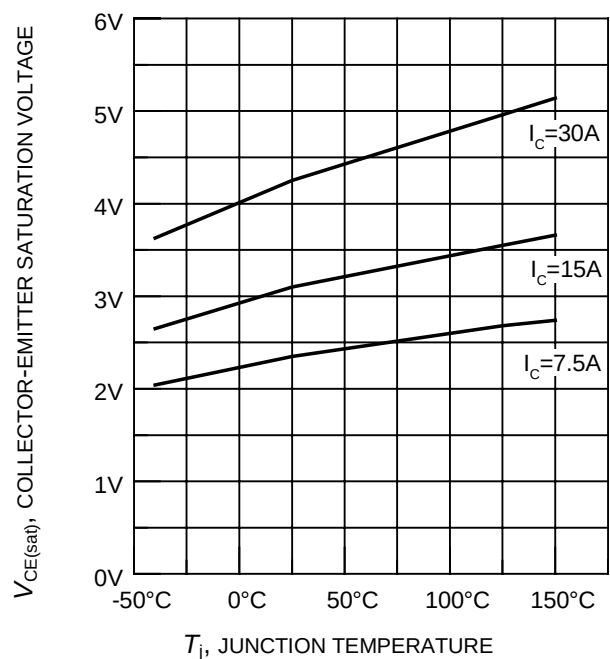
**Figure 5. Typical output characteristics**  
( $T_j = 25^\circ\text{C}$ )



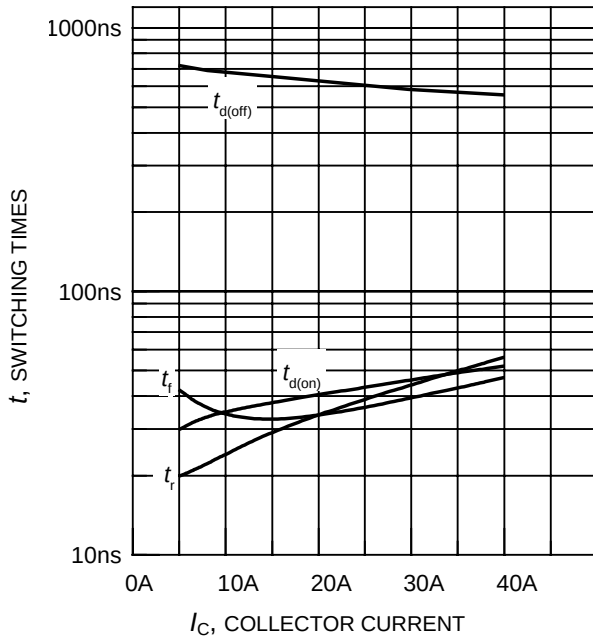
**Figure 6. Typical output characteristics**  
( $T_j = 150^\circ\text{C}$ )



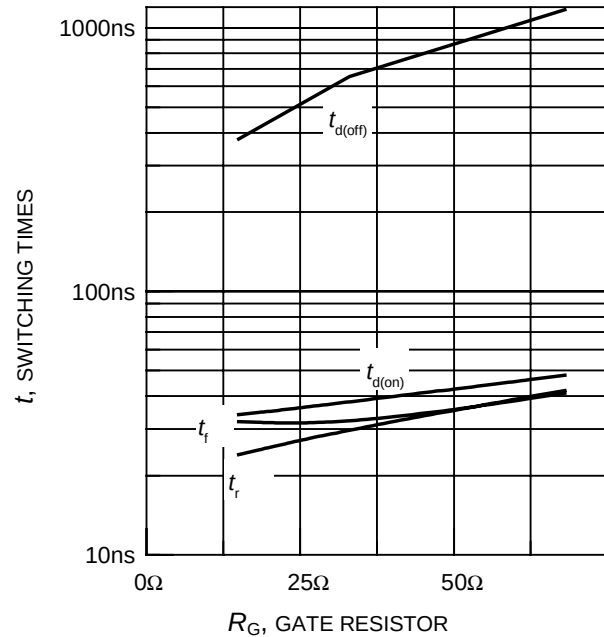
**Figure 7. Typical transfer characteristics**  
( $V_{CE} = 20\text{V}$ )



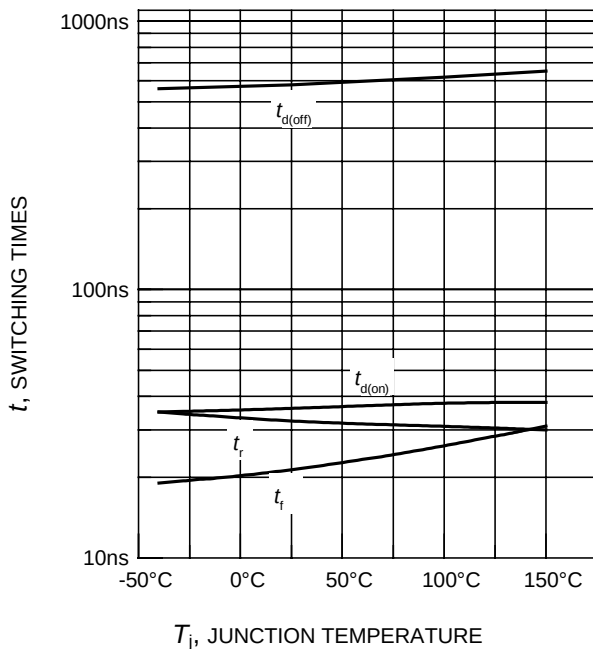
**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE} = 15\text{V}$ )



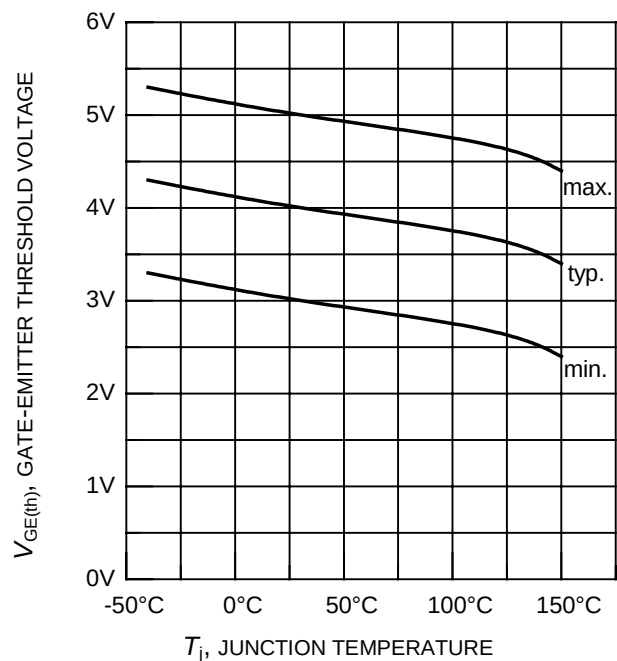
**Figure 9. Typical switching times as a function of collector current**  
(inductive load,  $T_j = 150^\circ\text{C}$ ,  
 $V_{CE} = 8600\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $R_G = 33\Omega$ ,  
dynamic test circuit in Fig.E )



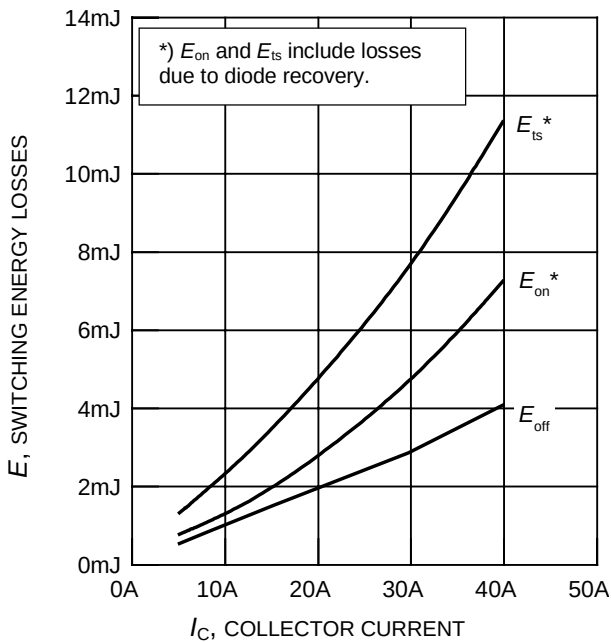
**Figure 10. Typical switching times as a function of gate resistor**  
(inductive load,  $T_j = 150^\circ\text{C}$ ,  
 $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 15\text{A}$ ,  
dynamic test circuit in Fig.E )



**Figure 11. Typical switching times as a function of junction temperature**  
(inductive load,  $V_{CE} = 800\text{V}$ ,  
 $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 15\text{A}$ ,  $R_G = 33\Omega$ ,  
dynamic test circuit in Fig.E )

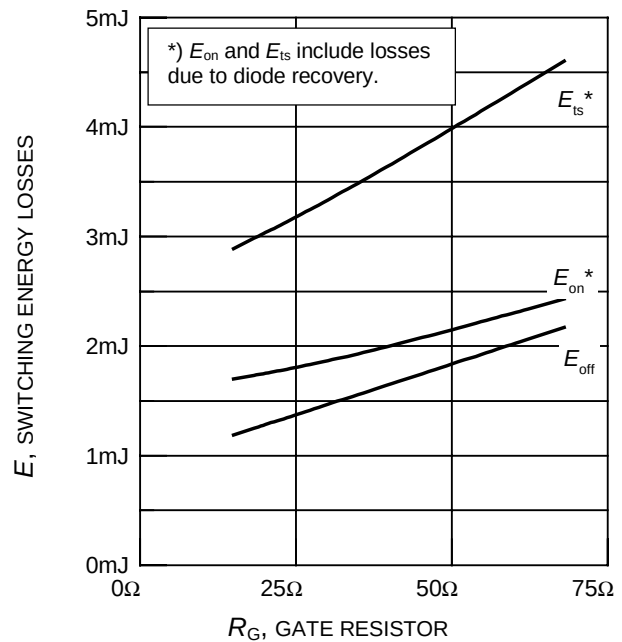


**Figure 12. Gate-emitter threshold voltage as a function of junction temperature**  
( $I_C = 0.3\text{mA}$ )



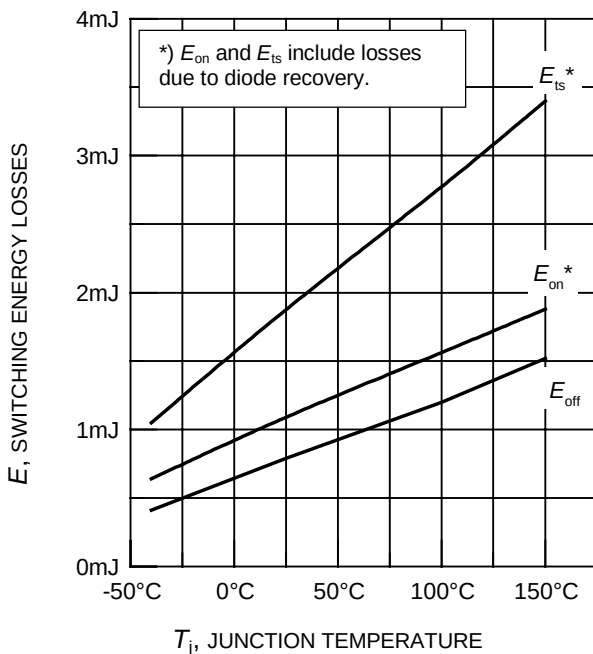
**Figure 13. Typical switching energy losses as a function of collector current**

(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $R_G = 33\Omega$ , dynamic test circuit in Fig.E )



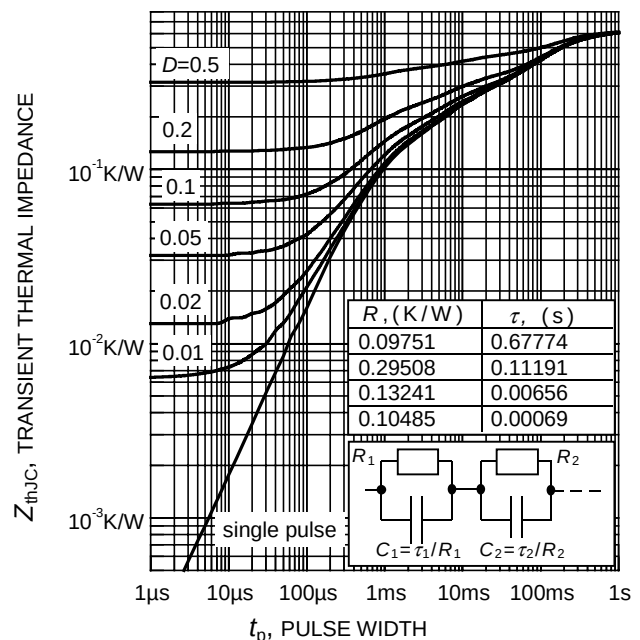
**Figure 14. Typical switching energy losses as a function of gate resistor**

(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 15\text{A}$ , dynamic test circuit in Fig.E )

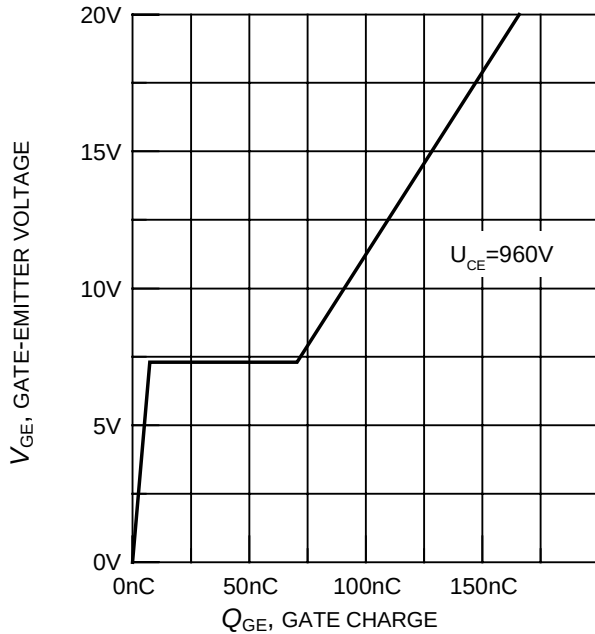


**Figure 15. Typical switching energy losses as a function of junction temperature**

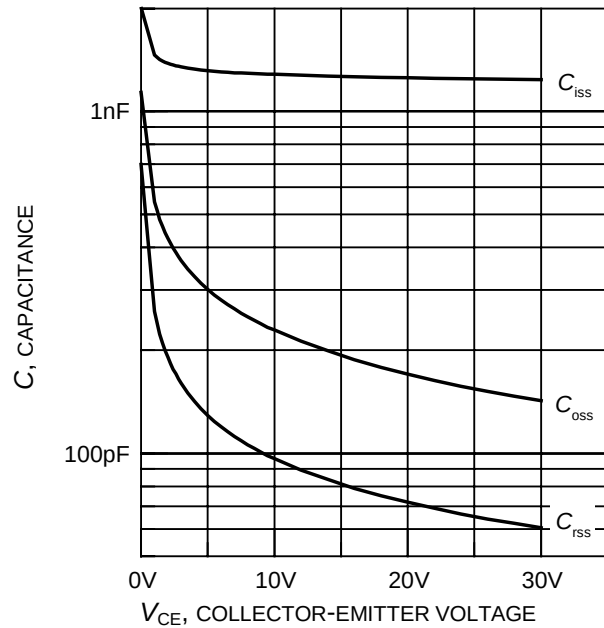
(inductive load,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 15\text{A}$ ,  $R_G = 33\Omega$ , dynamic test circuit in Fig.E )



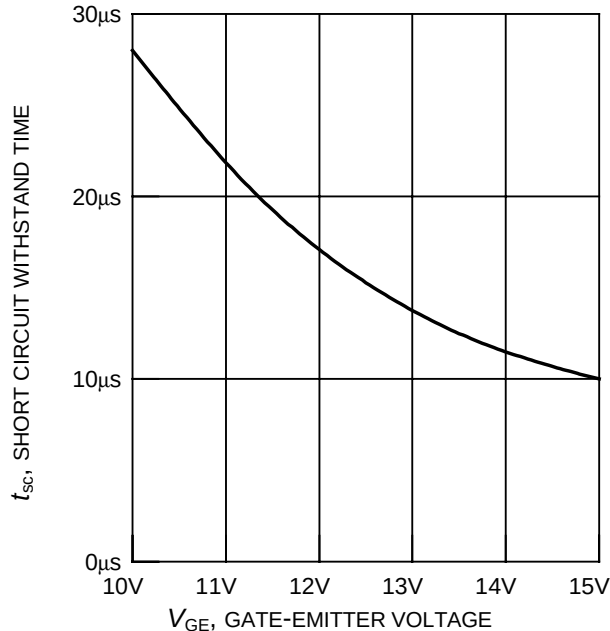
**Figure 16. IGBT transient thermal impedance as a function of pulse width**  
( $D = t_p / T$ )



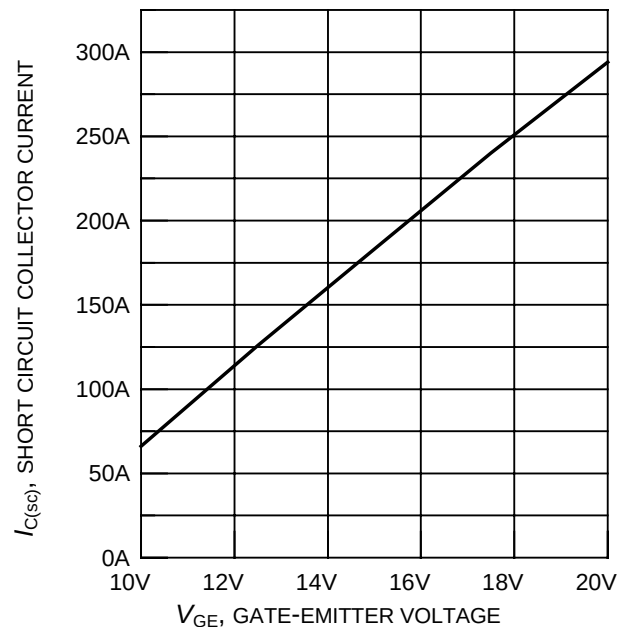
**Figure 17. Typical gate charge**  
( $I_C = 15A$ )



**Figure 18. Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE} = 0V$ ,  $f = 1MHz$ )

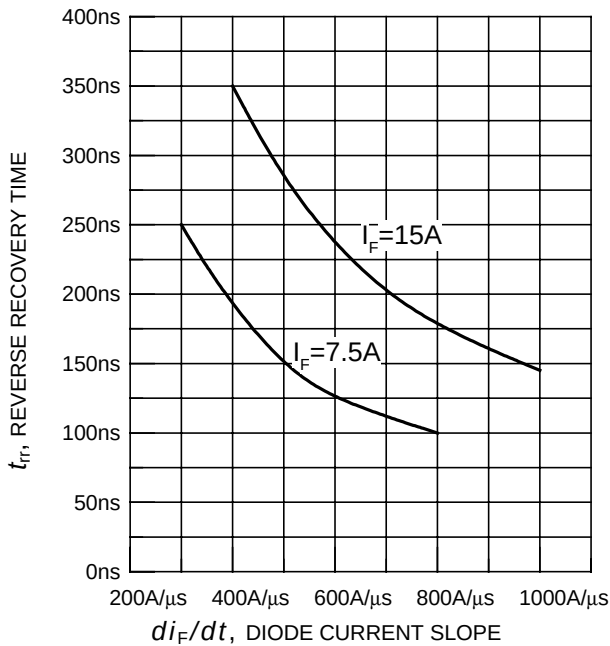


**Figure 19. Short circuit withstand time as a function of gate-emitter voltage**  
( $V_{CE} = 1200V$ , start at  $T_j = 25^\circ C$ )



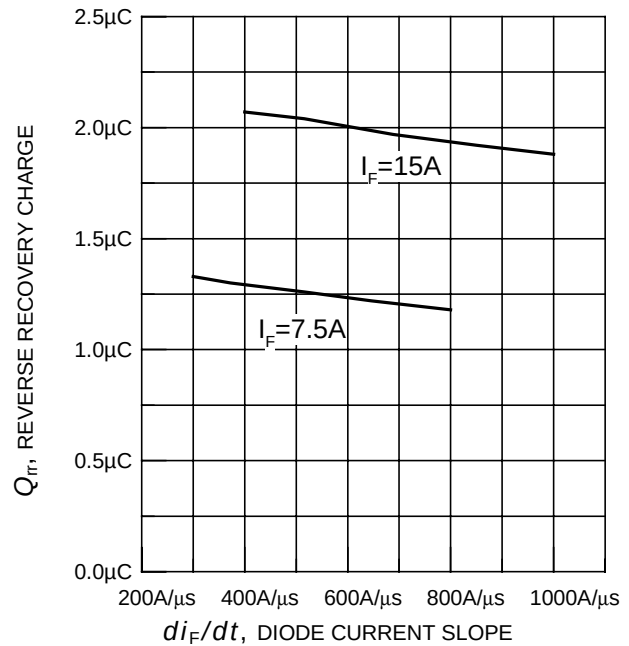
**Figure 20. Typical short circuit collector current as a function of gate-emitter voltage**  
( $100V \leq V_{CE} \leq 1200V$ ,  $T_C = 25^\circ C$ ,  $T_j \leq 150^\circ C$ )





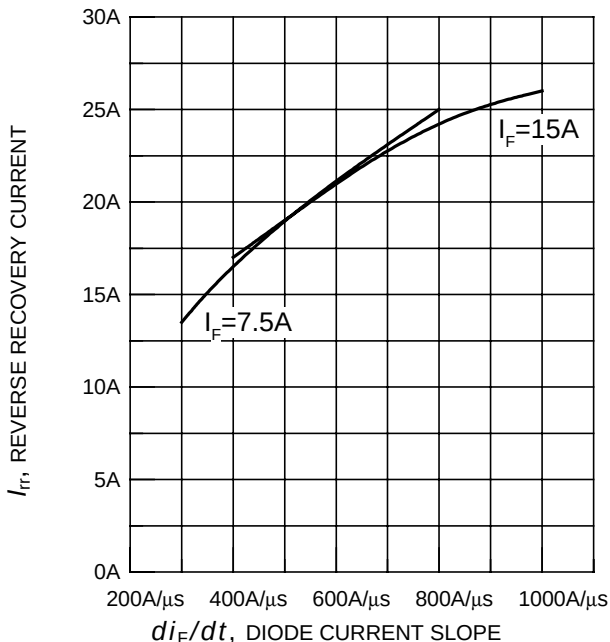
**Figure 21. Typical reverse recovery time as a function of diode current slope**

( $V_R = 800V$ ,  $T_J = 150^\circ C$ , dynamic test circuit in Fig.E )



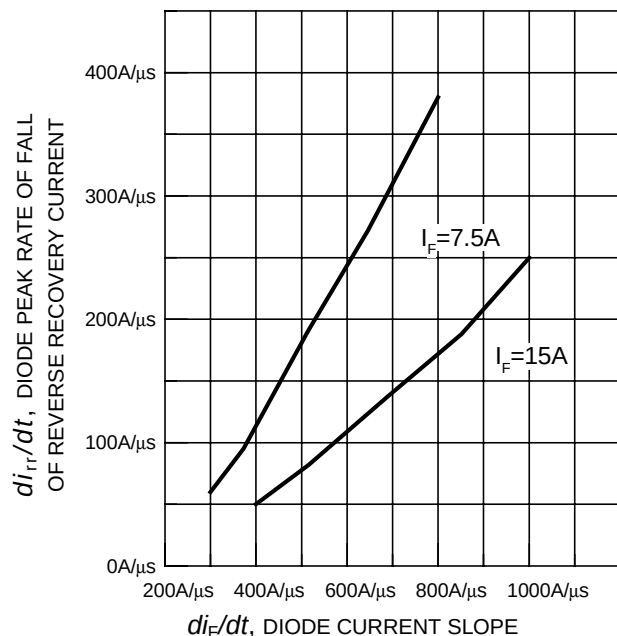
**Figure 22. Typical reverse recovery charge as a function of diode current slope**

( $V_R = 800V$ ,  $T_J = 150^\circ C$ , dynamic test circuit in Fig.E )



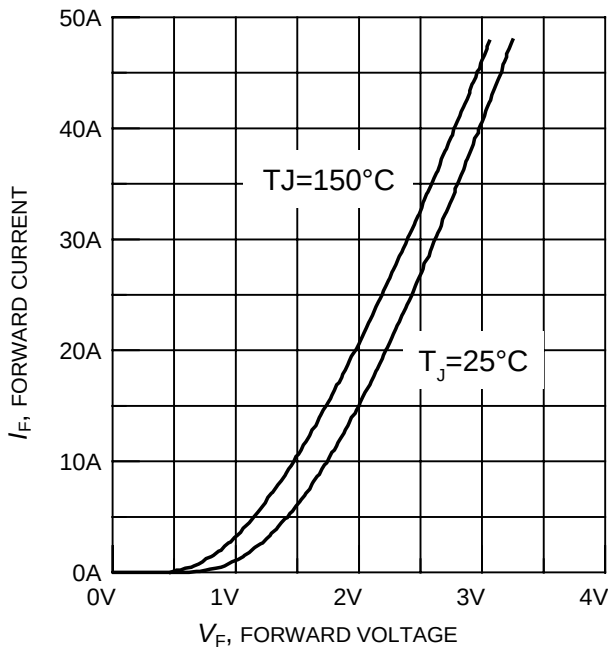
**Figure 23. Typical reverse recovery current as a function of diode current slope**

( $V_R = 800V$ ,  $T_J = 150^\circ C$ , dynamic test circuit in Fig.E )

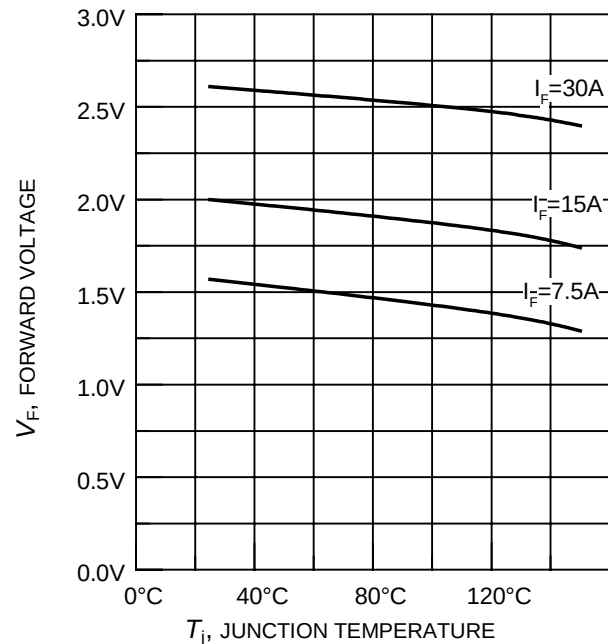


**Figure 24. Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**

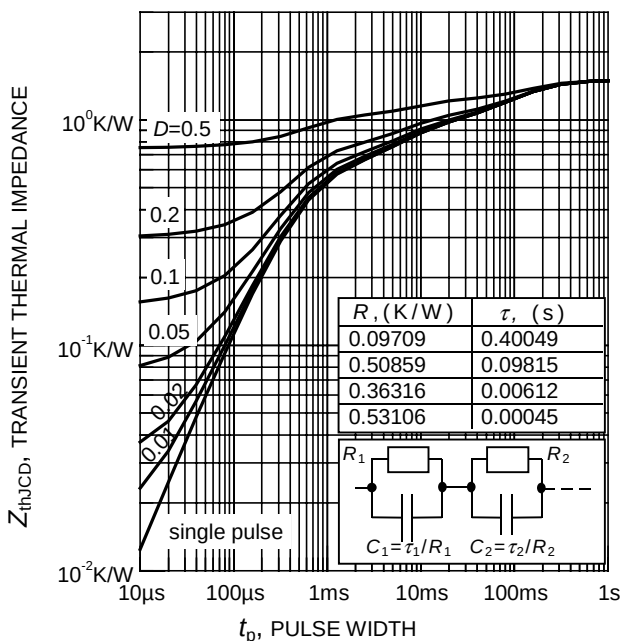
( $V_R = 800V$ ,  $T_J = 150^\circ C$ , dynamic test circuit in Fig.E )



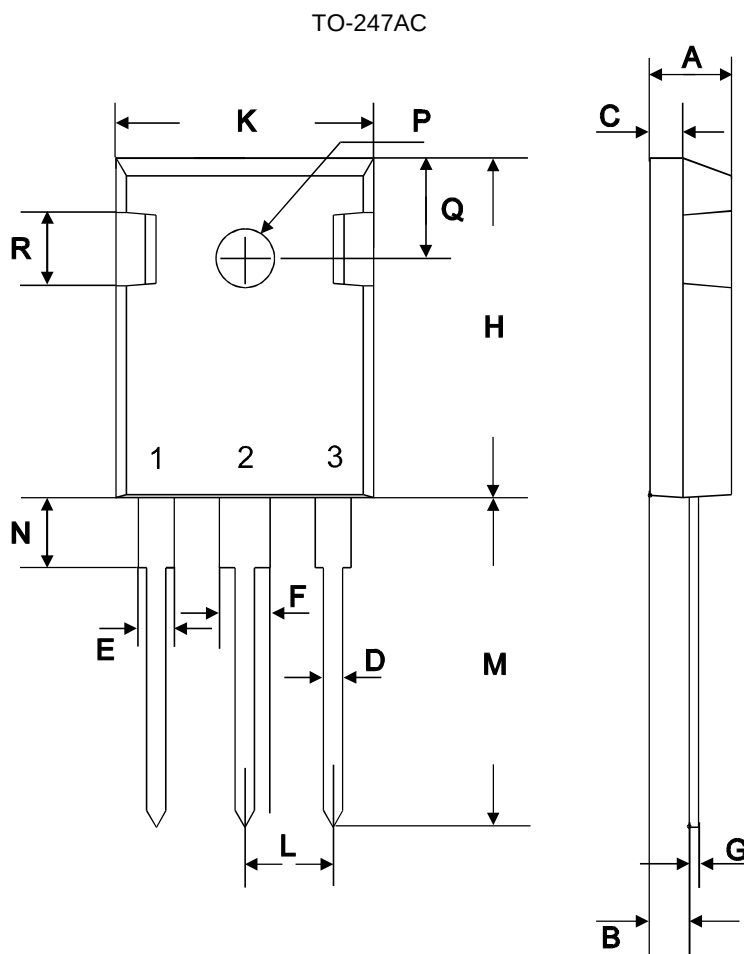
**Figure 25. Typical diode forward current as a function of forward voltage**



**Figure 26. Typical diode forward voltage as a function of junction temperature**



**Figure 27. Diode transient thermal impedance as a function of pulse width ( $D = t_p / T$ )**



| symbol | dimensions |       |            |        |
|--------|------------|-------|------------|--------|
|        | [mm]       |       | [inch]     |        |
|        | min        | max   | min        | max    |
| A      | 4.78       | 5.28  | 0.1882     | 0.2079 |
| B      | 2.29       | 2.51  | 0.0902     | 0.0988 |
| C      | 1.78       | 2.29  | 0.0701     | 0.0902 |
| D      | 1.09       | 1.32  | 0.0429     | 0.0520 |
| E      | 1.73       | 2.06  | 0.0681     | 0.0811 |
| F      | 2.67       | 3.18  | 0.1051     | 0.1252 |
| G      | 0.76 max   |       | 0.0299 max |        |
| H      | 20.80      | 21.16 | 0.8189     | 0.8331 |
| K      | 15.65      | 16.15 | 0.6161     | 0.6358 |
| L      | 5.21       | 5.72  | 0.2051     | 0.2252 |
| M      | 19.81      | 20.68 | 0.7799     | 0.8142 |
| N      | 3.560      | 4.930 | 0.1402     | 0.1941 |
| ØP     | 3.61       |       | 0.1421     |        |
| Q      | 6.12       | 6.22  | 0.2409     | 0.2449 |

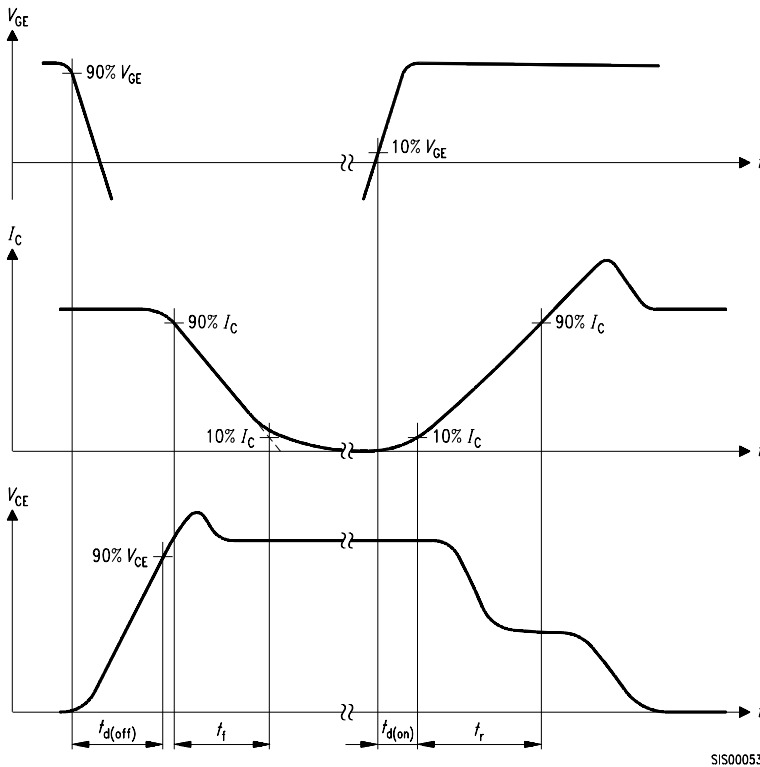


Figure A. Definition of switching times

SIS00053

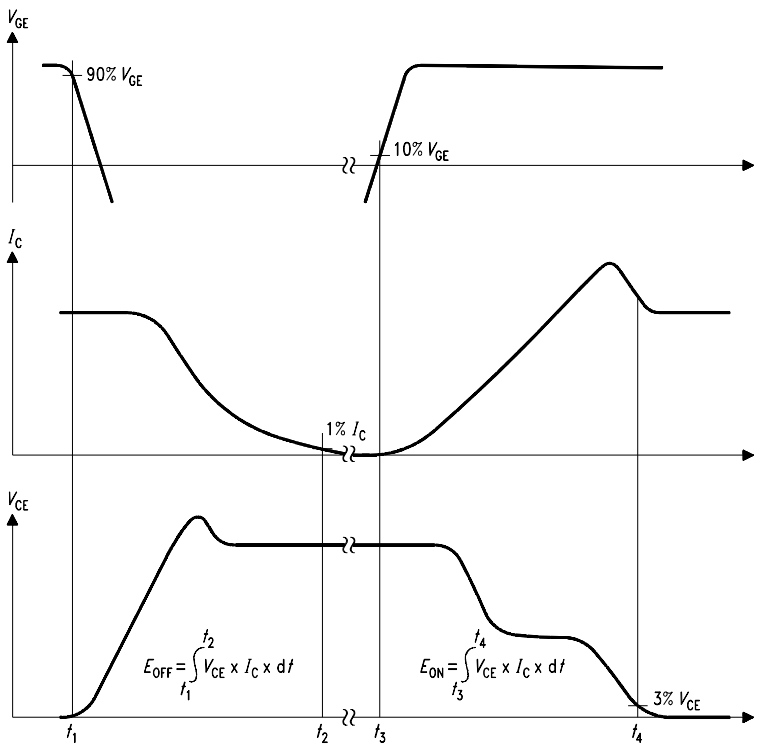


Figure B. Definition of switching losses

SIS00050

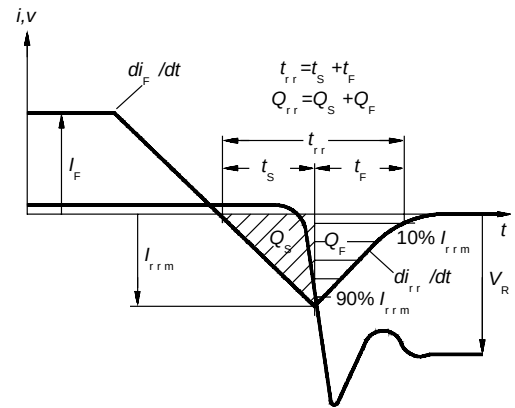


Figure C. Definition of diodes switching characteristics

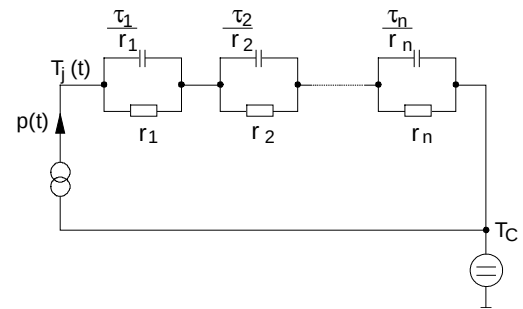


Figure D. Thermal equivalent circuit

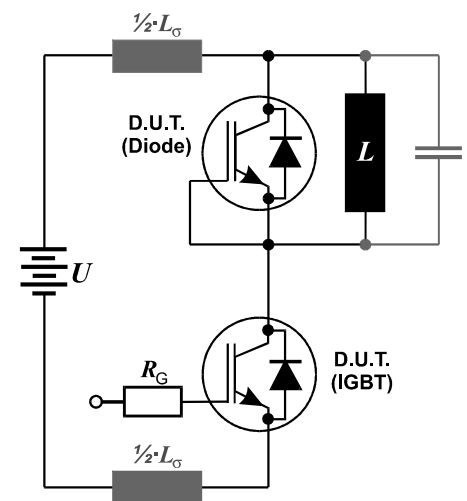


Figure E. Dynamic test circuit  
Leakage inductance  $L_{\sigma}=180\text{nH}$ ,  
and stray capacity  $C_{\sigma}=40\text{pF}$ .

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